

TI *Live!* INDIA AUTOMOTIVE SEMINAR

RAVNEET KOTWAL, STEVE FISHER

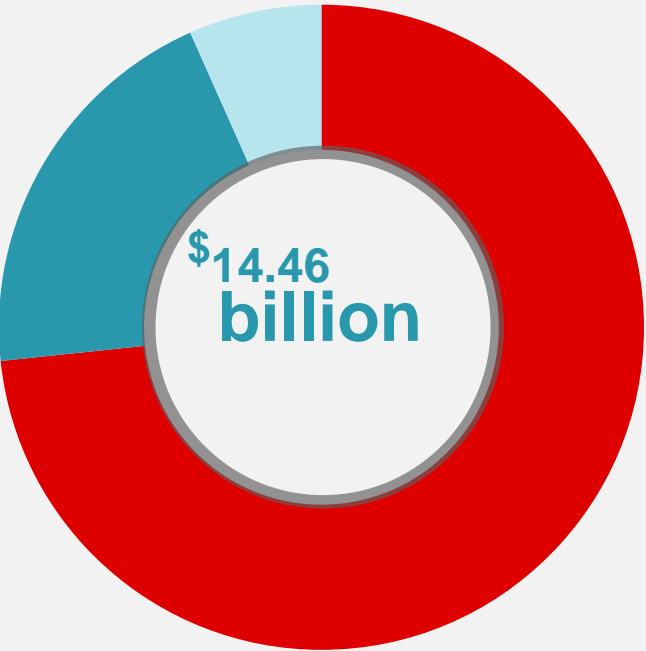
INAUGURAL KEYNOTE

Topics

- Company overview
- TI manufacturing
- Buying on TI.com
- TI automotive overview
- Inauguration for the seminar

Our company at a glance

Updated Oct. 15, 2021



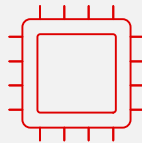
Revenue in 2020

- Analog: \$10.9 billion
- Embedded: \$2.6 billion
- Other: \$1.0 billion

Capital expenditures: \$649 million
R&D: \$1.5 billion

Industrial and automotive combined comprised 57% of TI's 2020 revenue

- Industrial: 37%
- Automotive: 20%
- Personal electronics: 27%
- Communications equipment: 8%
- Enterprise systems: 6%
- Other: 2%



80,000+ products for over 100,000 customers



15 manufacturing sites worldwide, tens of billions of chips produced each year

TI.com

Web presence, 110+ Sales & Applications sites across the globe



Barron's 100 Most Sustainable Companies

Humans Rights Campaign Corporate Equality Index, 100% rating

National Association for Female Executives, Top Companies for Executive Women

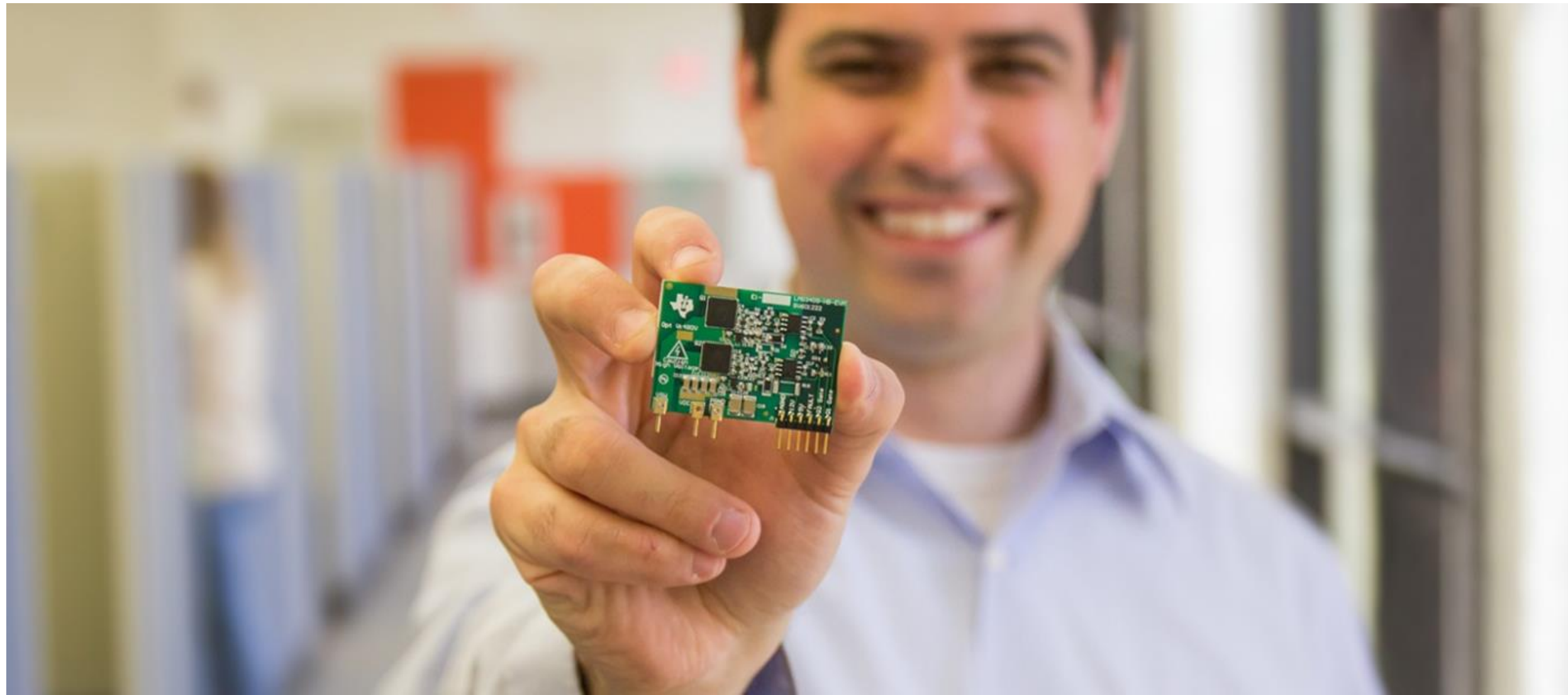
We design and manufacture analog and embedded semiconductors

Our 80,000 products are the essential building blocks of all types of electronics systems to help:

- Efficiently manage power
- Accurately sense and transmit data
- Provide the core control or processing

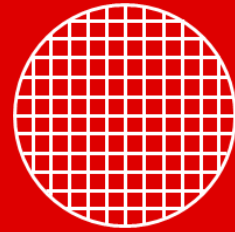
Our 100,000 customers are in all markets including:

- Industrial
- Automotive
- Personal electronics
- Communications equipment
- Enterprise systems



The benefits of working with TI

Diversity and longevity of our products, markets and customer positions



Assurance of supply continuity and commitment to product longevity

Reach of market channels



Large worldwide sales and applications team for local support, plus TI.com to conveniently select, design, purchase.

Broad portfolio of analog and embedded processing products



1000s of product families to meet your system solutions needs

Strong foundation of manufacturing and differentiated technology



In-house manufacturing capacity, process and package technologies for optimized designs, quality excellence

For more information, check out the “About TI” section of TI.com.

Great products, engineering expertise and support

PORTFOLIO

Analog Power
Products

Analog Signal
Chain

Embedded
Processing

DLP®
Products

Key markets



Industrial



Automotive



Personal electronics



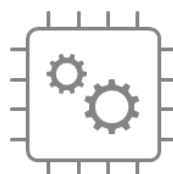
Communications
equipment



Enterprise systems

Technology and manufacturing

200-mm



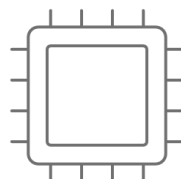
300-mm

Quality and reliability



Supply continuity
Multi-sourcing
On-time delivery

Support



Easy part
selection



Reference
designs



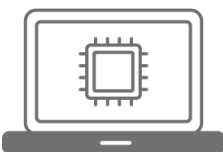
Online
support



TI.com



Training



Technical sales and
support



Buy on TI.com

TI manufacturing

Globally owned, regionally diverse manufacturing footprint



15 manufacturing sites worldwide, including wafer fabs, assembly and test factories, and bump and probe facilities.

Investing in 300-mm wafer fab capacity

DMOS6 – Dallas, TX



- Ramped for 300-mm analog technologies in 2014.

RFAB – Richardson, TX



- RFAB1: Ramped in 2010 as the world's first 300-mm analog wafer fab.
- RFAB2: 300-mm wafer fab expansion on existing Richardson site:
 - Equipment installations to begin in 1H 22.
 - First production output expected in 2H 22.

LFAB - Lehi, UT



- Acquisition completed in October 2021.
- Will run 65-nm and 45-nm production for TI's analog and embedded products.
- First output expected in early 2023.

New fabs in Sherman, TX



- Construction of new 300-millimeter wafer fabs in Sherman, Texas, announced in November 2021:
- Potential for up to four fabs to meet demand over time.
 - Construction of the first and second fabs is set to begin in 2022.
 - Production from the first new fab is expected as early as 2025.

45-nm – 130-nm technology nodes, optimized for analog and embedded products

Next 300-mm wafer fabs in Sherman, Texas



Design concept for Texas Instruments' new 300-millimeter semiconductor wafer fabs in Sherman, Texas. Construction of the first two fabs is to begin in 2022, with potential for up to four fabs over time.

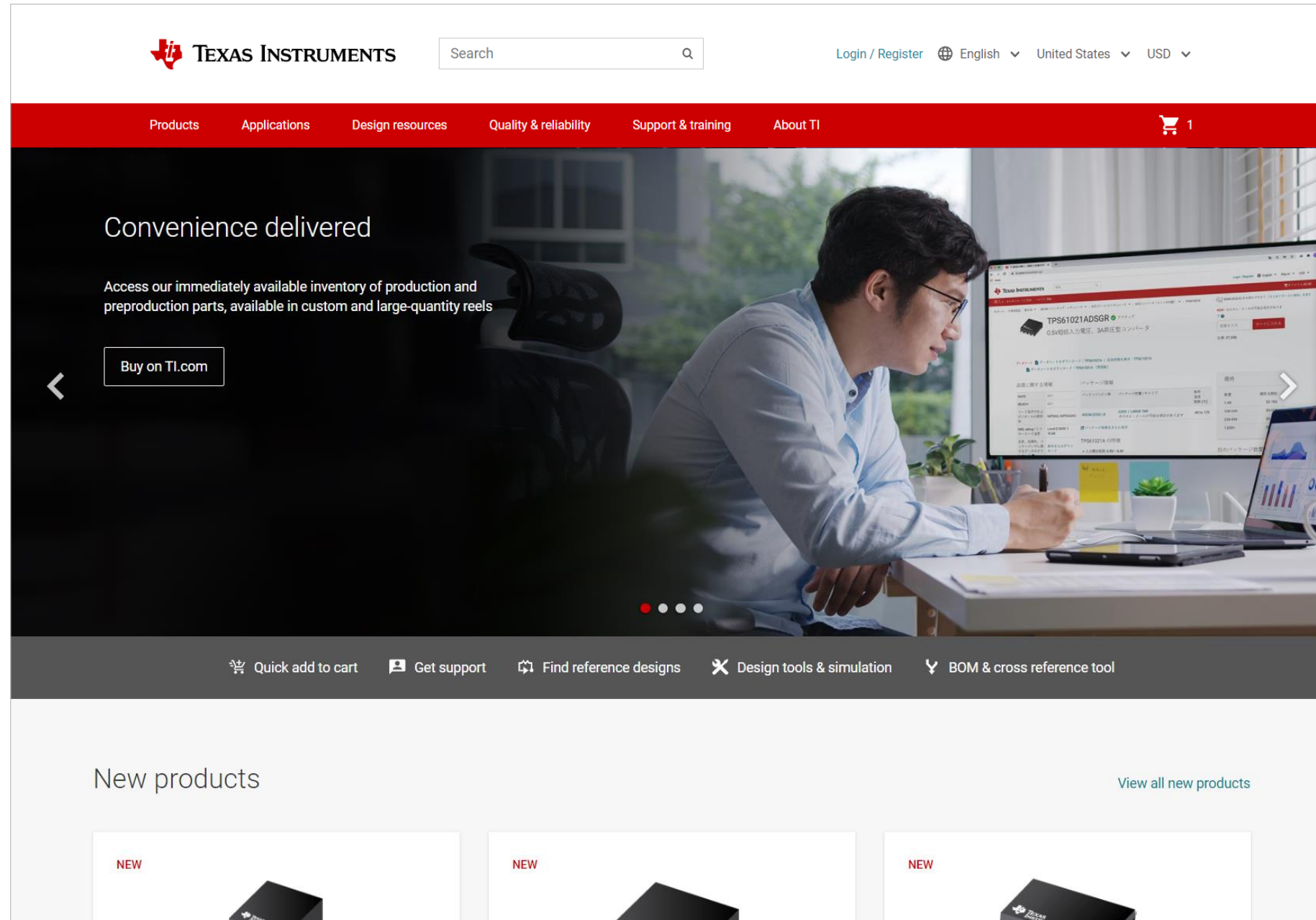
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Buying on TI.com

Convenience delivered

Aiming to provide you with **convenience**



Ordering resources and help

<https://www.ti.com/ordering-resources/buy.html>

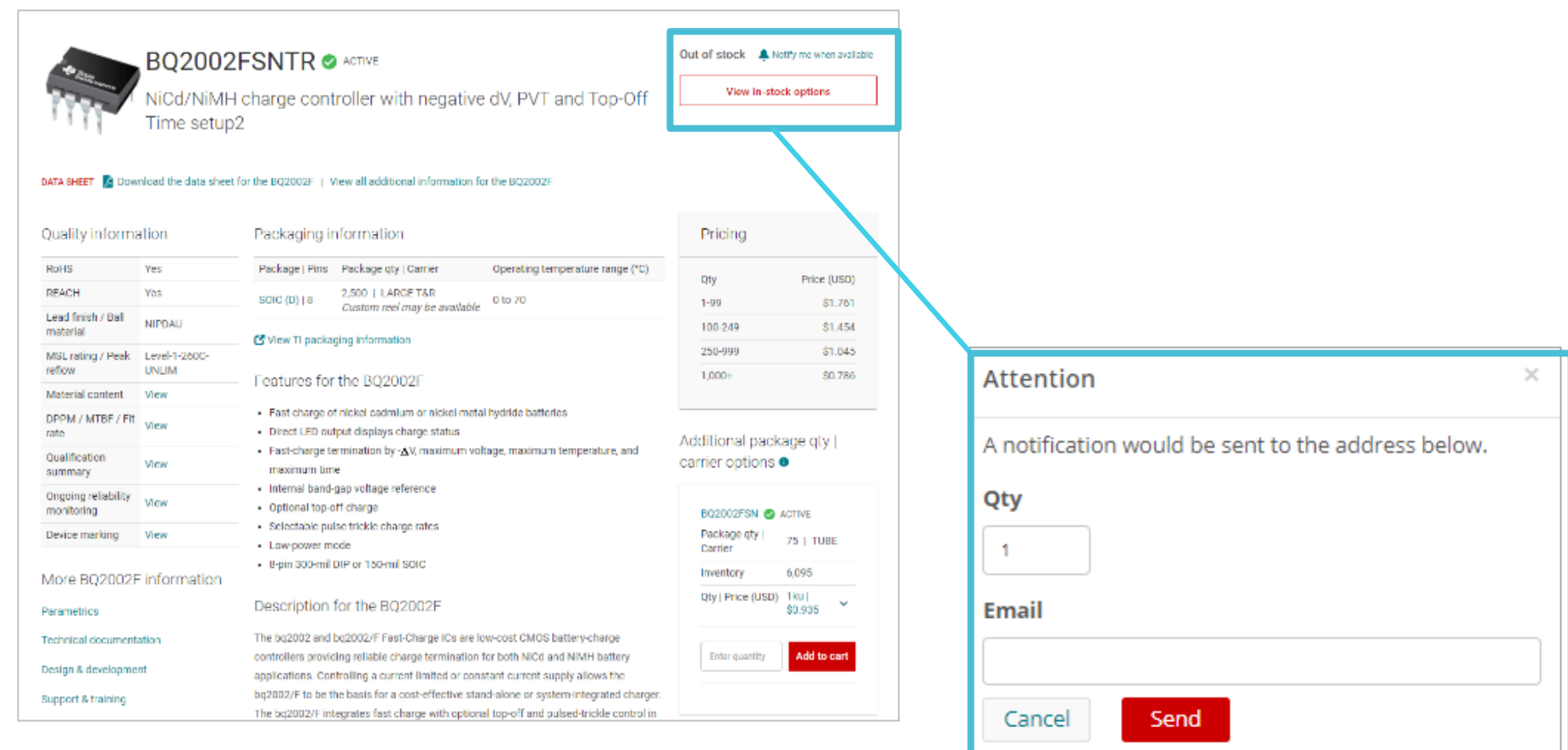
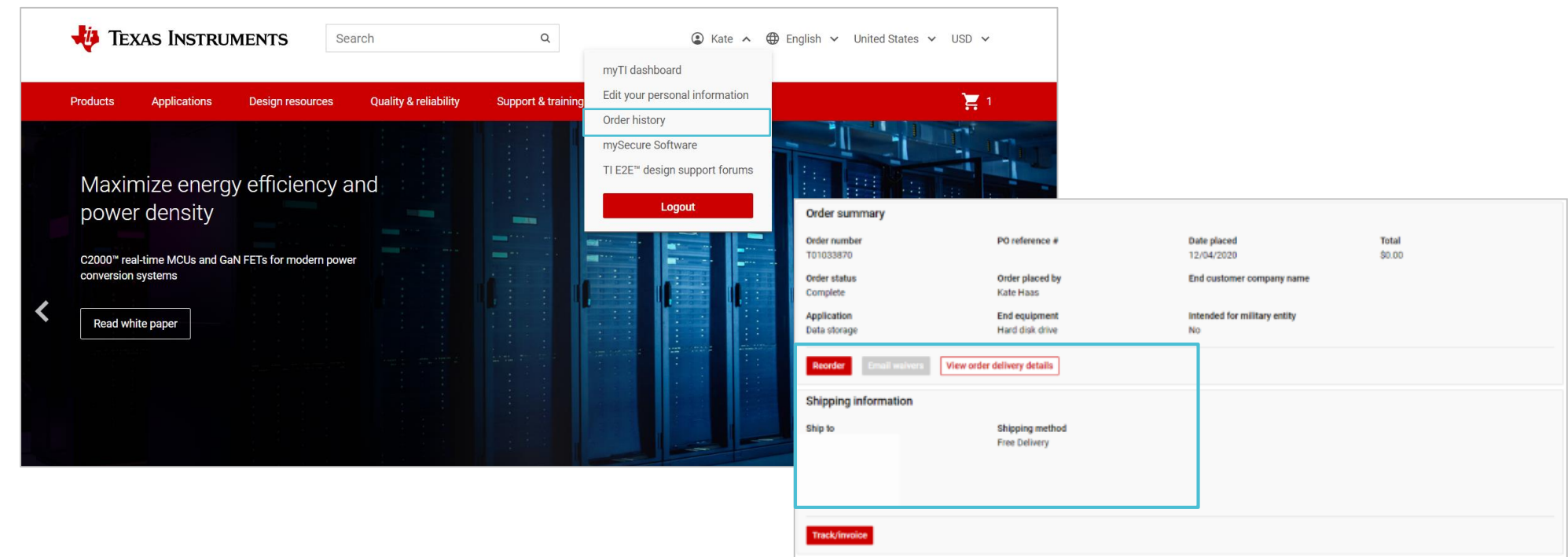
- Authentic TI products
- TI HiRel products with date and lot code options prior to ordering
- Lowest online prices*
- Cut tape, custom and full quantity reels
- Purchase in INR with TI as the importer of record to simplify delivery and customs clearance
- On-demand delivery and Self-service & ordering details
- Exclusive access to preproduction devices
- Quickly add multiple parts to your cart

**Lowest online prices on 1K unit quantities for 99% of TI's immediately available inventory. Excludes expired products and products sold by non-authorized sources.*

Self-service order and tracking details

Sign up and order with your myTI account to:

- Quickly reorder
- View order delivery details
- Get access to invoices and waivers
- Track shipments
- Receive back in stock notifications



Convenient payment options for India

Currency conversions to INR* & Line of credit (net 30 terms)

**conversion rate is calculated daily via Bloomberg*

Cart

1 item | ₹31,860.00

[Download cart](#)

ID: C11519816-UAT Name: Active cart

PO reference # ⓘ




End customer company name ⓘ

Optional

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Item	Package qty Carrier	Inventory	Qty	Carrier options	Unit price	Total	
<div><div></div><div><div>LP590712QDQNRQ1 ✓ ACTIVE</div><div>Automotive, 250-mA, low-noise, high-PSRR, ultra-low-dropout voltage regulator with low IQ and enable</div><div>Type : IC</div><div>Customer reference # ⓘ</div><div>Optional</div></div></div> <td>3,000 LARGE T&R</td> <td>5,891</td> <td><div>3000 ⓘ</div></td> <td>Full reel 3,000</td> <td><div>₹10.62</div></td> <td>₹31,860.00</td> <td></td>	3,000 LARGE T&R	5,891	<div>3000 ⓘ</div>	Full reel 3,000	<div>₹10.62</div>	₹31,860.00	

Coupon code

[Apply](#)

Subtotal

₹31,860.00

Order total (INR)

₹31,860.00

*Taxes are not included in the total

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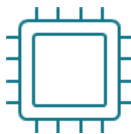
TI automotive overview

Accelerating the future of automotive systems



Our products and system expertise help you solve complex design challenges to get electrified, connected and automated cars to market faster.

Product innovation



7,000 automotive-qualified analog and embedded products



500 new automotive ICs annually since 2014

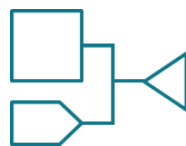


Decades of advancing automotive electronics

System expertise



150 automotive systems



350+ fully tested, circuit-based reference designs

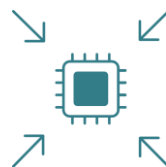


Meets rigorous quality requirements, including IATF, ISO and OHSAS certifications

Commitment to long-term supply



14 manufacturing sites worldwide



Proprietary processes and packaging



Proven track record of on-time delivery for product orders estimated ship date

Accelerating the future of automotive systems



Advanced driver assistance system

Advanced-assist and autonomous-driving capabilities for reducing human error

Passive safety systems

Reliable solutions to increase passenger safety



Body electronics and lighting

Innovative analog and embedded processors to optimize comfort and convenience



Infotainment and cluster

Immersive systems that keep drivers more informed and less distracted



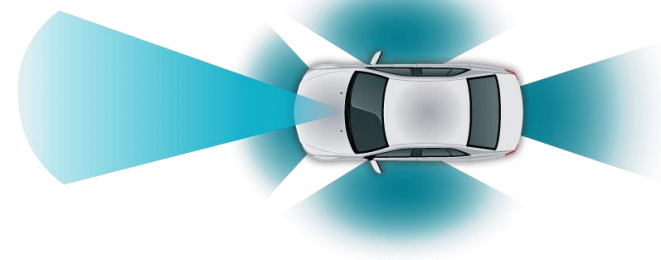
Hybrid and electric vehicles

Reducing emissions by electrifying systems from the car to the grid

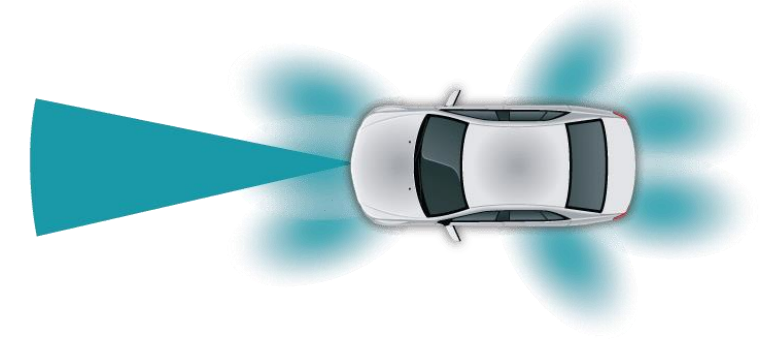
Advanced driver assistance systems



Enable assisted, automated driving features by accelerating ADAS design for a safer, less stressful driving experience.



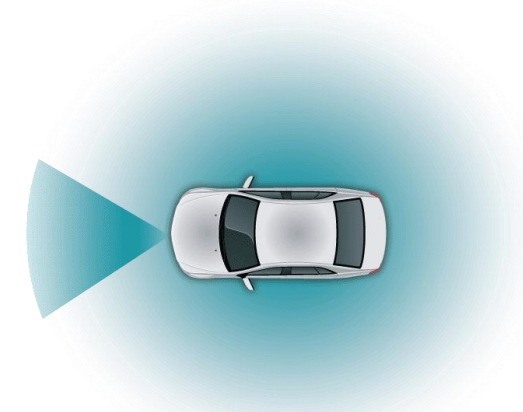
Camera



Radar



Sensor fusion



Lidar



Ultrasound

Infotainment & cluster systems



The next-generation digital cockpit.
Enable infotainment, display and V2X
systems that minimize distractions,
and help drivers stay informed and
connected to the world.



Cluster



Telematics



Display



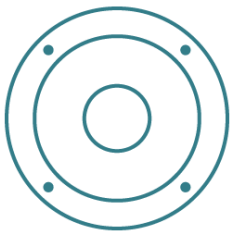
Integrated cockpit



Head unit

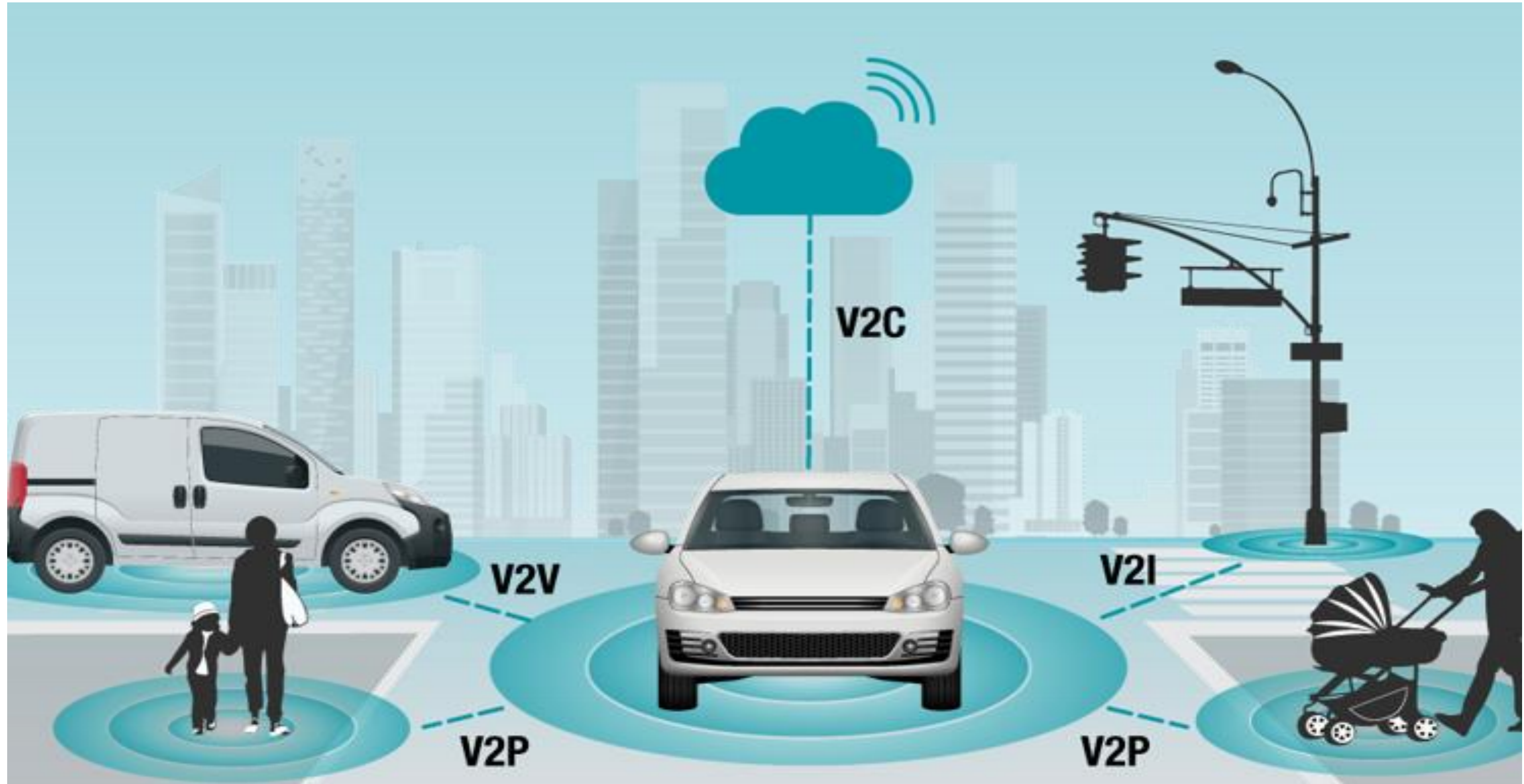


Media interface



Premium audio

Vehicle-to-everything (V2X)



V2X leads to safer and smarter autonomous driving

Adding a predictive element to a reactive system

Navigating obscured obstacles



- Blind intersections
- Non-Line of Sight (NLOS) scenarios

Conveying intent



- Pedestrians crossing the road
- Changing lanes

Environmental awareness



- Construction indication
- Stopped traffic
- Other hazards on the road

Data transmission



- Sharing updated road conditions
- Maintaining up-to-date firmware

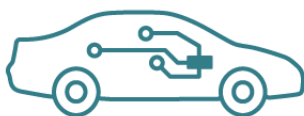
Body electronic & lighting systems



Optimize passenger comfort and convenience. Advance your body electronics and lighting system design with our smart, scalable and efficient solutions.



Automotive lighting



Body control module & gateway



Body motors



Heating & cooling



Car access and security systems



Power seats



Steering column



Automotive HMI



Mirrors



Body sensors



Auxiliary power

Top semiconductor technologies for lighting

Adaptive front light systems



Animated rear lights



Personalized zone lighting



Brighter, customized small lights



Transparent window display



Hybrid, electric & powertrain systems

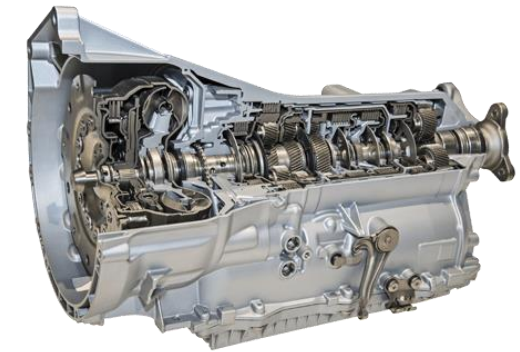


Giving you the power to electrify.
Accelerating EV and powertrain design
by innovating vehicle electrification to
reduce emissions, decrease weight
and boost efficiency with fewer
mechanical components.

Engine management



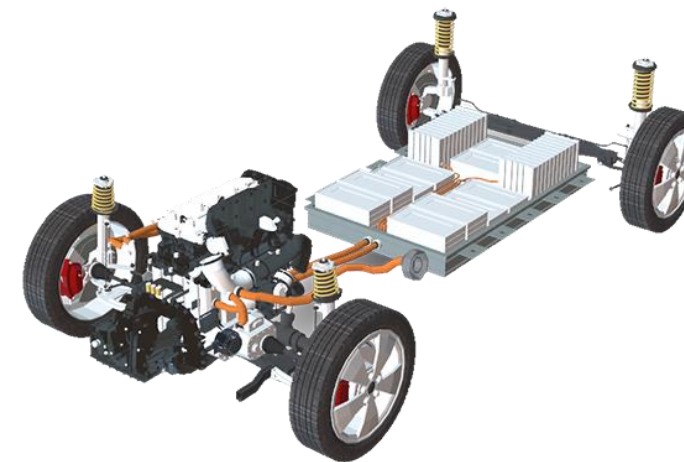
Transmission



HEV/EV



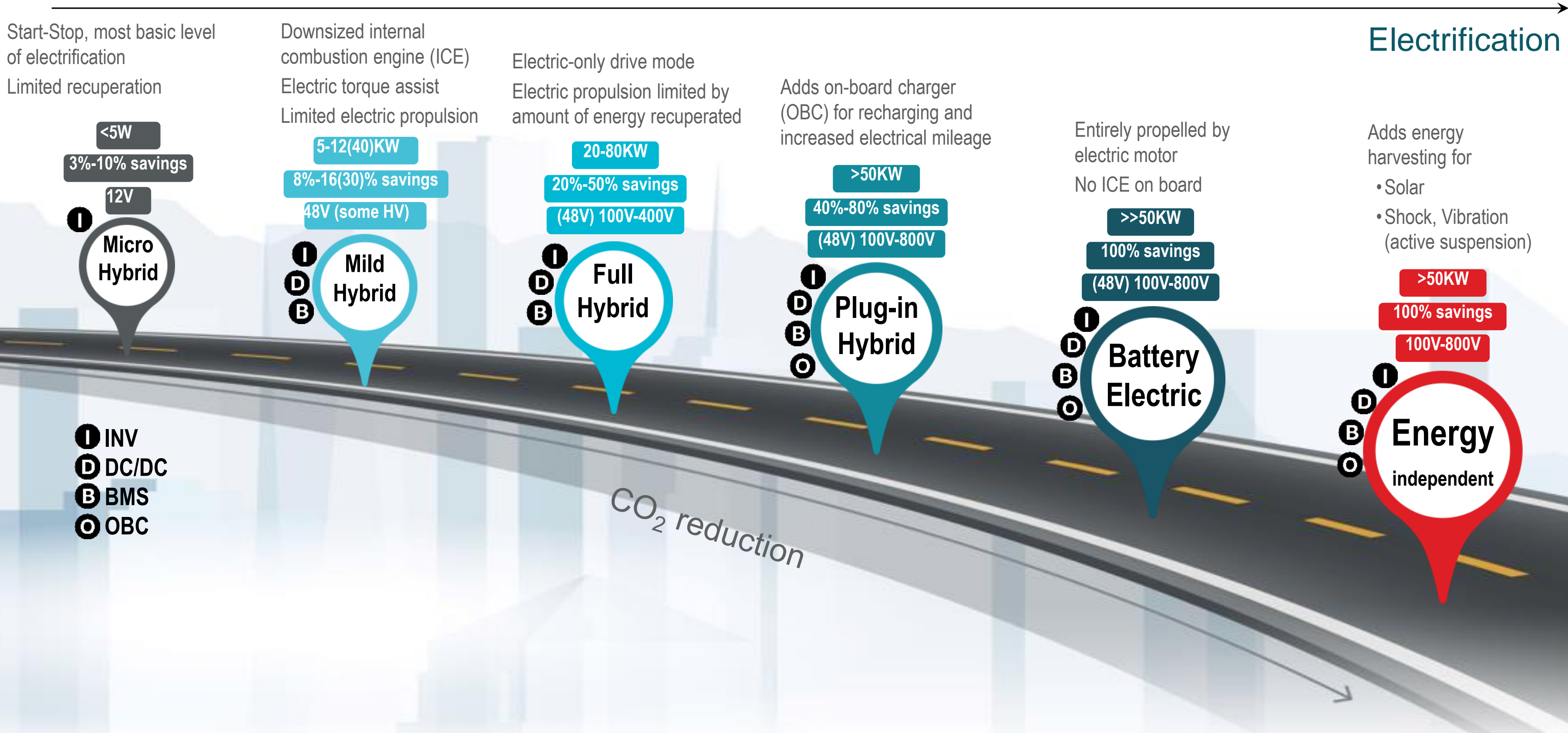
Powertrain sensors



Power steering



Road to zero-emission transportation

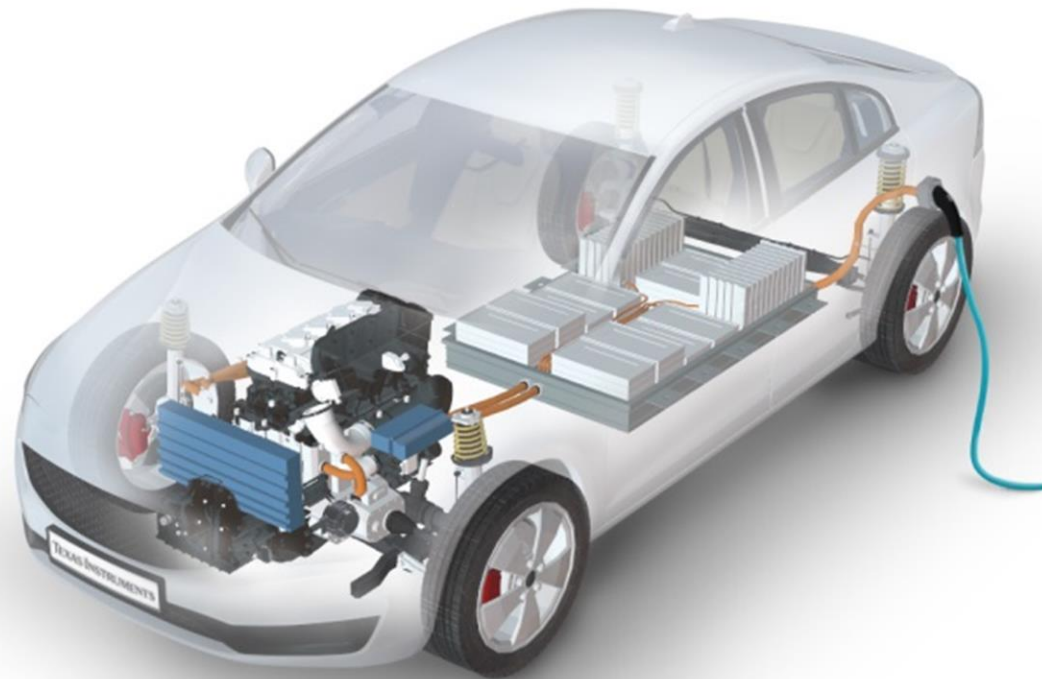


Powertrain system innovation

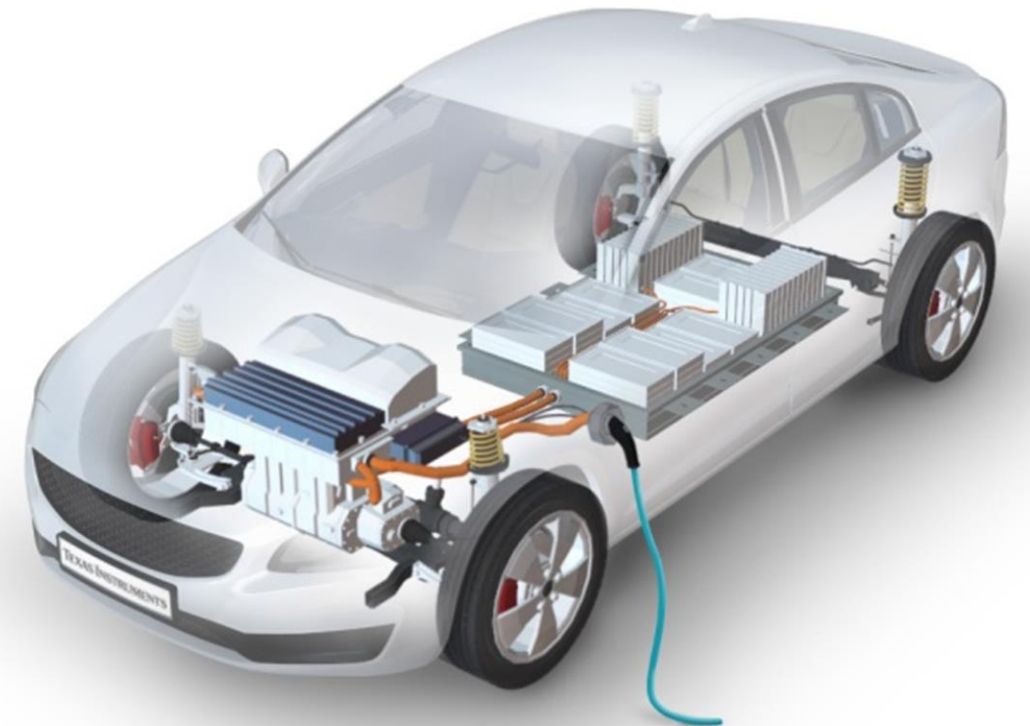
Internal combustion engine (ICE)



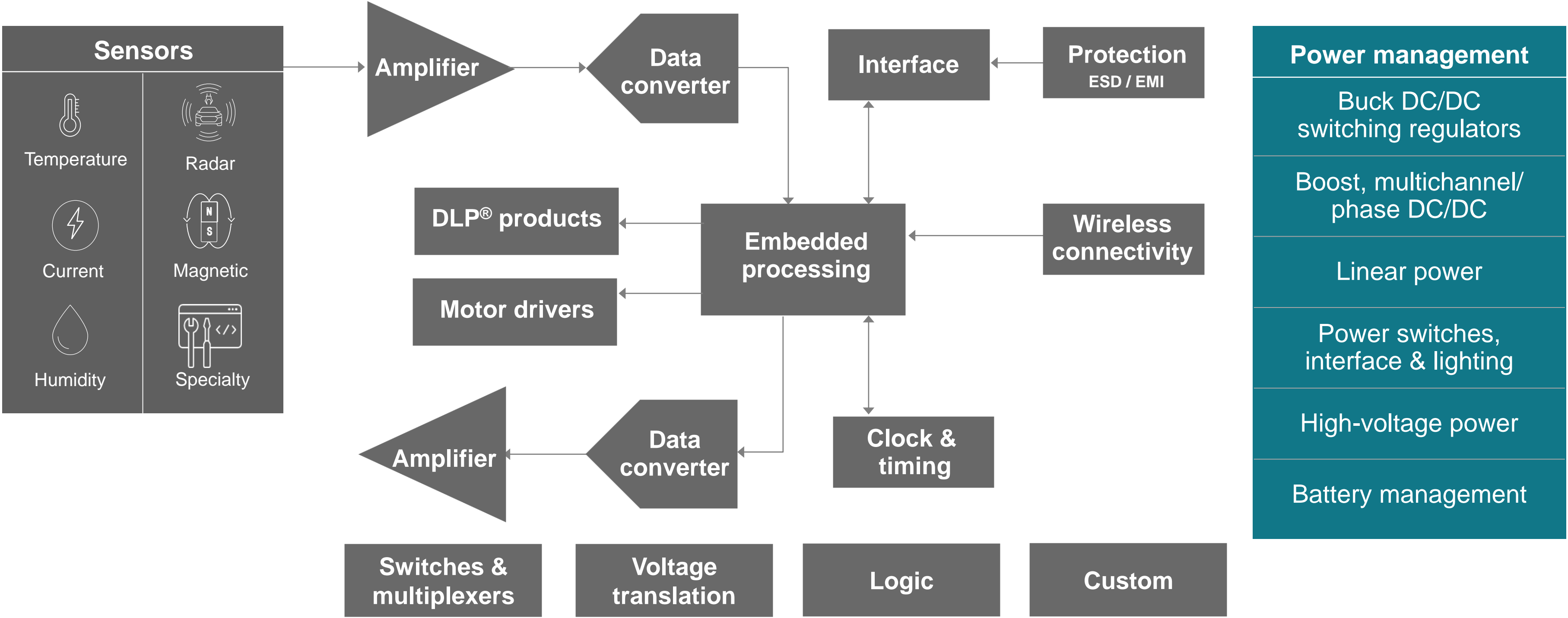
Hybrid electric vehicle (HEV)



Electric vehicle (EV)



Power, signal chain, embedded solutions



Thank you



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